

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT5383933

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	JIAXIANG SHI	02/15/2019
	VINAY SHARMA	02/15/2019
	INGO VOLKENING	02/15/2019
RECEIVING PARTY DATA		
Name:	INTEL CORPORATION	
Street Address:	2200 MISSION COLLEGE BOULEVARD	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	16280485	
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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ATTORNEY DOCKET NUMBER:	INTP731US	
NAME OF SUBMITTER:	JENNIFER N. HINTON	
SIGNATURE:	/Jennifer N. Hinton/	
DATE SIGNED:	02/20/2019	
Total Attachments: 4		
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source=Assignment#page2.tif		
source=Assignment#page3.tif		

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we,
the undersigned inventor(s):

Jiaxiang Shi; Vinay Sharma; & Ingo Volkening

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SELECTIVE DATA LANE INTERFACE MAPPING

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on _____ as

_____ Application Number _____ and
COUNTRY or International Office

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said

Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.



Inventor 1 Jiaxiang Shi

15-02-2019

Date signed

Docket No.: AB7323-US
Attorney Docket No.: INTP731US

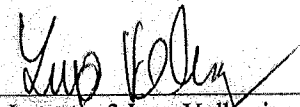
Vinay Sharma

Inventor 2 Vinay Sharma

15/2/2019

Date signed

Docket No.: AB7323-US
Attorney Docket No.: INTP731US



Inventor 3 Ingo Volkening

15/02/2019

Date signed